

Packaged and Bondable Chips

Features

- Low Series Resistance
- Fast Switching Speed
- Low Capacitance
- No Reverse Bias Required
- Available in Packages and Bondable Chips
- Available as Chip-on-Board Components

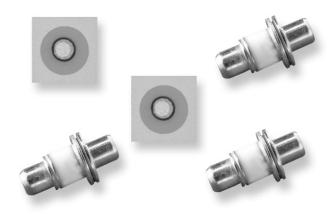
Applications

- Switches
- Attenuators
- Phase Shifters

Maximum Ratings

Reverse Voltage	Breakdown Voltage	
Forward Current	50 mA @ 25°C	
Incident Power	+20 dBm @ 25°C	
Operating Temperature	-55°C to +175°C	
Storage Temperature	-55°C to +200°C	

GaAs PIN DIODES MP61001 – MP61012



Description

Microsemi's GaAs PIN diodes are fabricated utilizing a gold contact mesa and protected with silicon nitride. The diodes have short carrier lifetime for fast switching speed and low series resistance. GaAs P00 diodes are available as bondable chips, chip-on-board components and in a variety of packages.

GaAs PIN diodes, in comparison to Si PIN diodes, reach its high impedance state at zero bias and do not require reverse bias for low loss. Nanosecond switching speed is achieved with GaAs PIN diodes, using low-cost TTL drivers.



GaAs PIN Diodes (Packaged and Bondable Chips)

	Max.	Min. Breakdown	Max. Resistance	Nominal Switching	Nominal
Deut Numeren	C _J @ -10 V ¹	Voltage	@ 20 mA ²	Speed	Carrier Lifetime ³
Part Number	(pf)	(V)	(Ω)	(ns)	(ns)
MP61001	0.03	200	3.0	20.0	50
MP61002	0.04	200	3.0	20.0	50
MP61003	0.05	200	3.0	20.0	50
MP61004	0.06	100	2.0	9.0	15
MP61005	0.07	100	2.0	9.0	15
MP61006	0.08	100	2.0	9.0	15
MP61007	0.10	75	2.0	6.0	10
MP61008	0.12	75	2.0	6.0	10
MP61009	0.15	50	1.0	3.5	5
MP61010	0.18	50	1.0	3.5	5
MP61011	0.23	50	0.8	3.5	5
MP61012	0.35	50	0.8	3.5	5

Callium Arsenide PIN Diodes (Specifications @ 25°C)

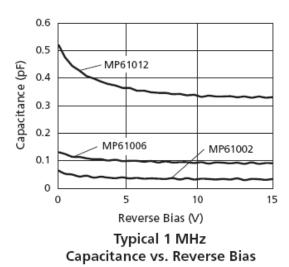
¹ Capacitance is specified at 1 MHz.

² Resistance is specified at 1 GHz.

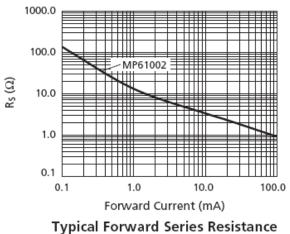
³ Carrier lifetime is inferred from stored charge measurement at 10 mA.

Note:

GaAs PIN diode chips have a minimum bonding area diameter of 50 microns.



Typical Characteristics



vs. Forward Current at 1 GHz

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Microchip:

 MP61007-P00
 MP61003-P00
 MP61004-30
 MP61001-P01
 MP61002-P00
 MP61008-P00
 MP61001-P00

 MP61004-P00
 MP61009-P00
 MP61001-30
 MP61003-M42
 MP61006-M42
 MP61010-M42
 MP61012-P00